

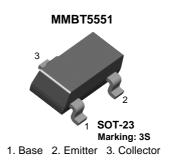
April 2006

2N5551- MMBT5551 NPN General Purpose Amplifier

Features

- This device is designed for general purpose high voltage amplifiers and gas discharge display drivers.
- Suffix "-C" means Center Collector in 2N5551 (1. Emitter 2. Collector 3. Base)
- Suffix "-Y" means h_{FE} 180~240 in 2N5551 (Test condition : I_C = 10mA, V_{CE} = 5.0V)





Absolute Maximum Ratings * Ta = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	160	V
V_{CBO}	Collector-Base Voltage	180	V
V_{EBO}	Emitter-Base Voltage	6.0	V
I _C	Collector current - Continuous	600	mA
T _J , T _{stg}	Junction and Storage Temperature	-55 ~ + 150	°C

 $^{^{\}star}$ These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

Thermal Characteristics Ta=25°C unless otherwise noted

Symbol	Parameter	М	Units	
		2N5551	*MMBT5551	Units
P _D	Total Device Dissipation Derate above 25°C	625 5.0	350 2.8	mW mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W

^{*} Device mounted on FR-4 PCB 1.6" \times 1.6" \times 0.06."

^{1.} These ratings are based on a maximum junction temperature of 150 degrees C.

^{2.} These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Electrical Characteristics $T_a = 25$ °C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Charact	eristics	1			
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage *	$I_C = 1.0 \text{mA}, I_B = 0$	160		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_E = 0$	180		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = 10uA, I_C = 0$	6.0		V
I _{CBO}	Collector Cutoff Current	V _{CB} = 120V, I _E = 0 V _{CB} = 120V, I _E = 0, T _a = 100°C		50 50	nA μA
I _{EBO}	Emitter Cutoff Current	V _{EB} = 4.0V, I _C = 0		50	nA
On Charact	eristics				
h _{FE}	DC Current Gain	I_{C} = 1.0mA, V_{CE} = 5.0V I_{C} = 10mA, V_{CE} = 5.0V I_{C} = 50mA, V_{CE} = 5.0V	80 80 30	250	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = 10\text{mA}, I_B = 1.0\text{mA}$ $I_C = 50\text{mA}, I_B = 5.0\text{mA}$		0.15 0.20	V V
V _{BE(sat)}	Base-Emitter On Voltage	$I_C = 10\text{mA}, I_B = 1.0\text{mA}$ $I_C = 50\text{mA}, I_B = 5.0\text{mA}$		1.0 1.0	V V
Small Signa	al Characteristics				
f _T	Current Gain Bandwidth Product	I _C = 10mA, V _{CE} = 10V, f = 100MHz	100	300	MHz
C _{obo}	Output Capacitance	$V_{CB} = 10V, I_{E} = 0, f = 1.0MHz$		6.0	pF
C _{ibo}	Input Capacitance	$V_{BE} = 0.5V, I_{C} = 0, f = 1.0MHz$		20	pF
H _{fe}	Small-Signal Current Gain	Ic = 1.0 mA, VcE = 10 V, f = 1.0kHz	50	250	
NF	Noise Figure	Ic = 250 uA, VcE = 5.0 V, Rs=1.0 kΩ, f=10 Hz to 15.7 kHz		8.0	dB

Spice Model

NPN (ls=2.511f Xti=3 Eg=1.11 Vaf=100 Bf=242.6 Ne=1.249 lse=2.511f lkf=.3458 Xtb=1.5 Br=3.197 Nc=2 lsc=0 lkr=0 Rc=1 Cjc=4.883p Mjc=.3047 Vjc=.75 Fc=.5 Cje=18.79p Mje=.3416 Vje=.75 Tr=1.202n Tf=560p ltf=50m Vtf=5 Xtf=8 Rb=10)

Typical Performance Characteristics

Figure 1. Typical Pulsed Current Gain vs Collector Current

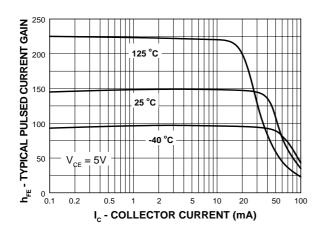


Figure 2. Collector-Emitter Saturation Voltage vs Collector Current

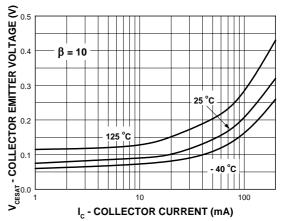


Figure 3. Base-Emitter Saturation Voltage vs Collector Current

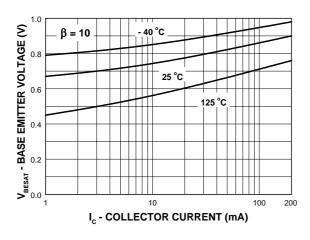


Figure 4. Base-Emitter On Voltage vs Collector Current

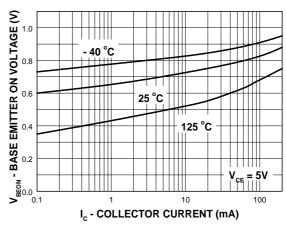


Figure 5. Collector Cutoff Current vs Ambient Temperature

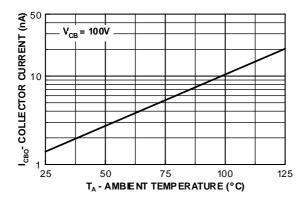
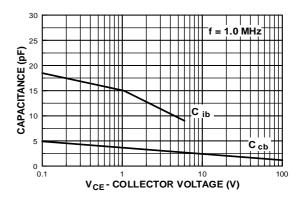


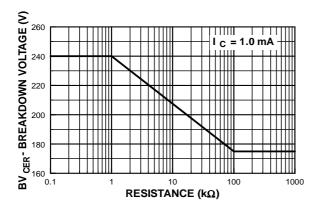
Figure 6. Input and Output Capacitance vs Reverse Voltage



Typical Performance Characteristics (Continued)

Figure 7. Collector- Emitter Breakdown Voltage with Resistance Between Emitter-Base vs Collector Current





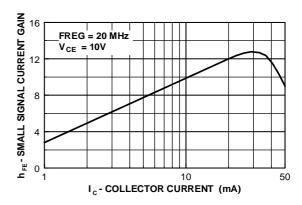
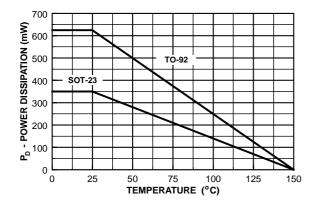


Figure 9. Power Dissipation vs Ambient Temperature



TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx™	FAST [®]	ISOPLANAR™	PowerEdge™	SuperFET™
ActiveArray™	FASTr™	LittleFET™	PowerSaver™	SuperSOT™-3
Bottomless™	FPS™	MICROCOUPLER™	PowerTrench [®]	SuperSOT™-6
Build it Now™	FRFET™	MicroFET™	QFET [®]	SuperSOT™-8
CoolFET™	GlobalOptoisolator™	MicroPak™	QS TM	SyncFET™
CROSSVOLT™	GTO™	MICROWIRE™	QT Optoelectronics™	TCM™
DOME™	HiSeC™	MSX™	Quiet Series™	TinyLogic [®]
EcoSPARK™	I^2C^{TM}	MSXPro™	RapidConfigure™	TINYOPTO™
E ² CMOS™	i-Lo™	OCXTM	RapidConnect™	TruTranslation™
EnSigna™	ImpliedDisconnect™	OCXPro™	μSerDes™	UHC™
FACT™	IntelliMAX™	OPTOLOGIC [®]	ScalarPump™	UltraFET [®]
FACT Quiet Series™		OPTOPLANAR™	SILENT SWITCHER®	UniFET™
Across the board. Around the world.™		PACMAN™	SMART START™	VCX™
The Power Franchise®		POP™	SPM™	Wire™
Programmable Active Droop™		Power247™	Stealth™	

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semi- conductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

Rev. I19